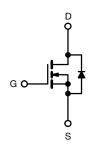
Vishay Siliconix

E Series Power MOSFET





N-Channel MOSFET

PRODUCT SUMMAR	Y	
V _{DS} (V) at T _J max.	85	0
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V	1.1
Q _g max. (nC)	32	2
Q _{gs} (nC)	Q _{gs} (nC) 4	
Q _{gd} (nC)	6	;
Configuration	Sing	gle

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

RoHS COMPLIANT HALOGEN FREE

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
- Induction heating
- Motor drives
- Battery chargers
- Renewable energy
- Solar (PV inverters)

ORDERING INFORMATION	
Package	DPAK (TO-252)
	SiHD4N80E-GE3
Load (Dh) free and helegan free	SiHD4N80ET1-GE3
Lead (Pb)-free and halogen-free	SiHD4N80ET4-GE3
	SiHD4N80ET5-GE3

ABSOLUTE MAXIMUM RATINGS (T_C	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V_{DS}	800	V
Gate-source voltage			V_{GS}	± 30	
Continuous drain current (T, = 150 °C)	V _{GS} at 10 V	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$	l-	4.3	
Continuous drain current (1) = 150 C)	VGS at 10 V	T _C = 100 °C	I _D	2.7	Α
Pulsed drain current ^a			I _{DM}	11	
Linear derating factor				0.56	W/°C
Single pulse avalanche energy ^b	Single pulse avalanche energy b		E _{AS}	56	mJ
Maximum power dissipation			P_{D}	69	W
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope	T _J = 125 °C		dv/dt	70	V/ns
Reverse diode dv/dt ^d			uv/ut	0.3	V/fis
Soldering recommendations (peak temperature) ^c	For	10 s		300	°C

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 2.0 A
- c. 1.6 mm from case
- d. $I_{SD} \leq I_{D}$, di/dt = 100 A/ μ s, starting T_{J} = 25 °C



Vishay Siliconix

THERMAL RESISTANCE RATI	NGS			
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R _{thJA}	-	62	°C/W
Maximum junction-to-case (drain)	R_{thJC}	-	1.8	C/ VV

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static				•	l .	•	
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	800	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	1.1	-	V/°C
Gate-source threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	2.0	-	4.0	V
Cata assura laskana			V _{GS} = ± 20 V	-	-	± 100	nA
Gate-source leakage	I _{GSS}		$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μΑ
Zana mata walta na dinaina awanant		V _{DS} =	= 800 V, V _{GS} = 0 V	-	-	1	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 640 \	/, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 2 A	-	1.1	1.27	Ω
Forward transconductance	9 _{fs}	V _{DS}	s = 30 V, I _D = 2 A	-	1.5	-	S
Dynamic							
Input capacitance	C _{iss}	$V_{GS} = 0 V$,		-	622		
Output capacitance	C _{oss}		$V_{DS} = 100 \text{ V},$	-	34	-	1
Reverse transfer capacitance	C _{rss}	f = 1 MHz		-	5	-	1
Effective output capacitance, energy related ^a	C _{o(er)}	V 0V 400V V 0V		-	21	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}	V _{DS} = 0 \	$V_{DS} = 0 \text{ V to } 480 \text{ V}, V_{GS} = 0 \text{ V}$		91	-	
Total gate charge	Qg			-	16	32	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$I_D = 2 A, V_{DS} = 480 V$	-	4	-	nC
Gate-drain charge	Q _{gd}			-	6	-	
Turn-on delay time	t _{d(on)}			-	12	24	
Rise time	t _r	Von	V_{DD} = 480 V, I_{D} = 2 A, V_{GS} = 10 V, R_{g} = 9.1 Ω		7	14	
Turn-off delay time	t _{d(off)}				26	52	ns
Fall time	t _f				20	40	
Gate input resistance	R_g	f = 1	f = 1 MHz, open drain		1.2	2.4	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I _S	MOSFET symbol showing the		-	-	4.4	
Pulsed diode forward current	I _{SM}	integral revers p - n junction	₹	-	-	11	A
Diode forward voltage	V _{SD}	T _J = 25 °	°C, I _S = 2 A, V _{GS} = 0 V	-	-	1.2	V
Reverse recovery time	t _{rr}			-	248	496	ns
Reverse recovery charge	Q _{rr}		5 °C, I _F = I _S = 2 A,	-	1.4	2.8	μC
Reverse recovery current	I _{RRM}	di/dt = 100 A/μs, V _R = 25 V		-	9.2	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 V to 480 V V_{DSS}

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 V to 480 V VDSS



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

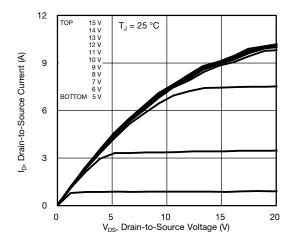


Fig. 1 - Typical Output Characteristics

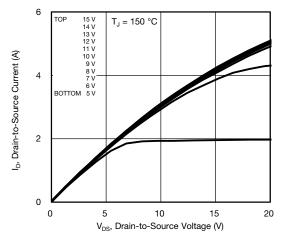


Fig. 2 - Typical Output Characteristics

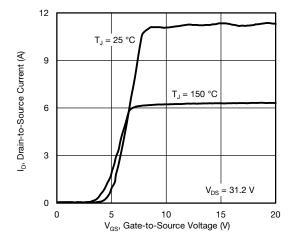


Fig. 3 - Typical Transfer Characteristics

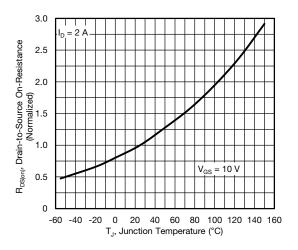


Fig. 4 - Normalized On-Resistance vs. Temperature

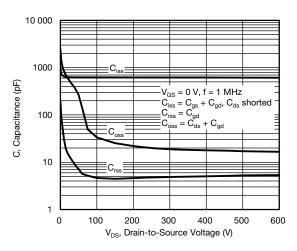


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

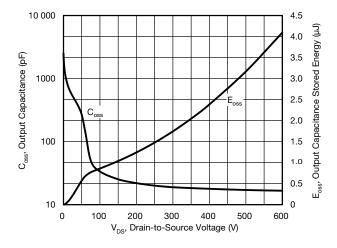


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}



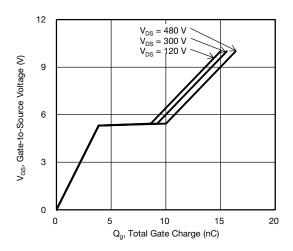


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

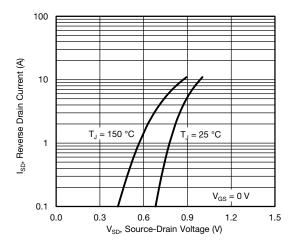


Fig. 8 - Typical Source-Drain Diode Forward Voltage

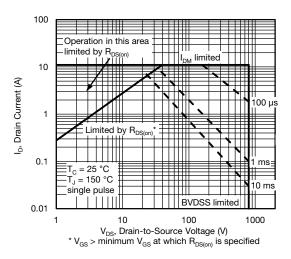


Fig. 9 - Maximum Safe Operating Area

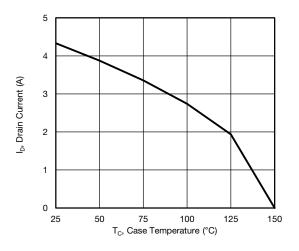


Fig. 10 - Maximum Drain Current vs. Case Temperature

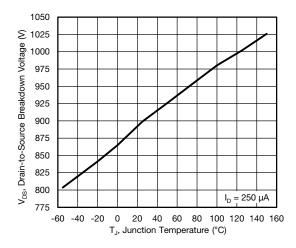


Fig. 11 - Temperature vs. Drain-to-Source Voltage



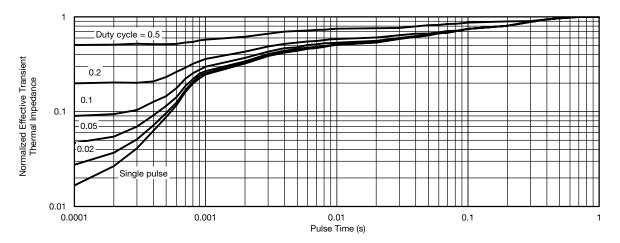


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

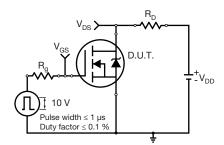


Fig. 13 - Switching Time Test Circuit

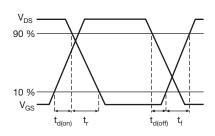


Fig. 14 - Switching Time Waveforms

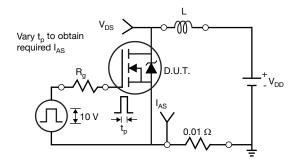


Fig. 15 - Unclamped Inductive Test Circuit

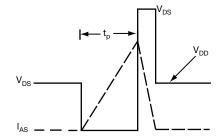


Fig. 16 - Unclamped Inductive Waveforms

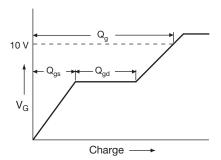
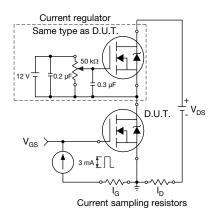


Fig. 17 - Basic Gate Charge Waveform

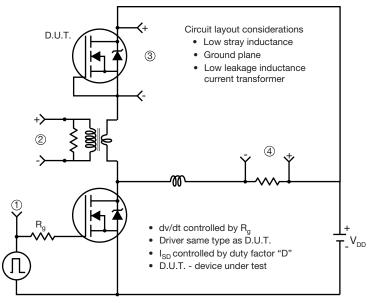




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Fig. 18 - Gate Charge Test Circuit

Peak Diode Recovery dv/dt Test Circuit



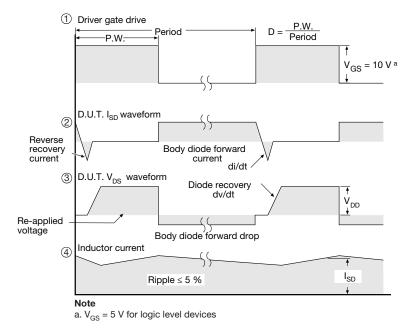
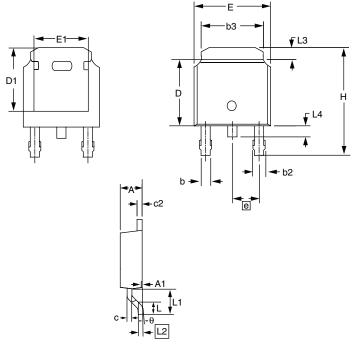


Fig. 19 - For N-Channel

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TO-252AA (HIGH VOLTAGE)



	MILLI	METERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
Е	6.40	6.73	0.252	0.265	
L	1.40	1.77	0.055	0.070	
L1	2.74	2.743 REF		REF	
L2	0.50	8 BSC	0.020) BSC	
L3	0.89	1.27	0.035	0.050	
L4	0.64	1.01	0.025	0.040	
D	6.00	6.22	0.236	0.245	
Н	9.40	10.40	0.370	0.409	
b	0.64	0.88	0.025	0.035	
b2	0.77	1.14	0.030	0.045	
b3	5.21	5.46	0.205	0.215	
е	2.28	2.286 BSC) BSC	
Α	2.20	2.38	0.087	0.094	
A1	0.00	0.13	0.000	0.005	
С	0.45	0.60	0.018	0.024	
c2	0.45	0.58	0.018	0.023	
D1	5.30	-	0.209	-	
E1	4.40	-	0.173	-	
θ	0'	10'	0'	10'	

ECN: S-81965-Rev. A, 15-Sep-08

DWG: 5973

Notes

- 1. Package body sizes exclude mold flash, protrusion or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 0.10 mm per side.
- 2. Package body sizes determined at the outermost extremes of the plastic body exclusive of mold flash, gate burrs and interlead flash, but including any mismatch between the top and bottom of the plastic body.
- 3. The package top may be smaller than the package bottom.
- 4. Dimension "b" does not include dambar protrusion. Allowable dambar protrusion shall be 0.10 mm total in excess of "b" dimension at maximum material condition. The dambar cannot be located on the lower radius of the foot.

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RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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